

Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
20	0.046 at V _{GS} = 4.5 V	6	3.5 nC			
	0.063 at V _{GS} = 2.5 V	6	3.5 110			

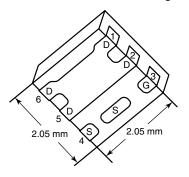
PowerPAK SC-70-6L-Single

FEATURES

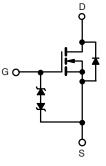
- Halogen-free According to IEC 61249-2-21
- TrenchFET[®] Power MOSFET
 New Thermally Enhanced PowerPAK[®]
- SC-70 Package
 Small Footprint Area
 - Low On-Resistance
- Typical ESD Protection 1200 V

APPLICATIONS

- Load Switch for Portable Applications
- High Frequency DC/DC Converter



Marking Code



N-Channel MOSFET

Ordering Information: SiA438EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 12	v	
	T _C = 25 °C		6 ^a		
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C	I _D	6 ^a		
	T _A = 25 °C	.0	5.7 ^{b, c}		
	T _A = 70 °C		4.5 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	15		
Continuous Source-Drain Diode Current	T _C = 25 °C		6 ^a		
	T _A = 25 °C	I _S	1.75 ^{b, c}		
	T _C = 25 °C		11.4		
Maximum Power Dissipation	T _C = 70 °C	P _D	7.3	w	
	T _A = 25 °C		2.4 ^{b, c}	VV	
	T _A = 70 °C		1.5 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	0 °	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	41	52	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	9	11	0/11	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Solder Profile (<u>www.vishay.com/ppg273257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 90 °C/W.



FREE



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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		N 01/1 050 A		1	1	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- I _D = 250 μA		23		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 3.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 70		
		$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1	- μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 V, V_{GS} = 0 V$			- 1		
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	10			Α	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$		0.037	0.046		
Drain-Source On-State Resistance ^a		V _{GS} = 2.5 V, I _D = 3.3 A		0.051	0.063	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 3.9 A		14		S	
Dynamic ^b				•	•	L	
Input Capacitance	C _{iss}			350	1	[
Output Capacitance	C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		63		pF	
Reverse Transfer Capacitance	C _{rss}			37			
	-155	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.1 \text{ A}$		7.5	12		
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.1 \text{ A}$		3.5	5.5	nC	
Gate-Source Charge	Q _{gs}			0.95	0.0		
Gate-Drain Charge	Q _{gd}			0.75			
Gate Resistance	Rg	f = 1 MHz		3.5		Ω	
Turn-On Delay Time	t _{d(on)}			10	15	32	
Rise Time	t _r	-		10	20		
		V_{DD} = 10 V, R_L = 2.4 Ω		12	30	-	
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong4.1$ A, V_{GEN} = 4.5 V, R_{g} = 1 Ω		-			
Fall Time	t _f			12	20	ns	
Turn-On Delay Time	t _{d(on)}	-		5	10	-	
Rise Time	t _r	V_{DD} = 10 V, R_L = 2.4 Ω		12	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 4.1$ A, V_{GEN} = 10 V, R_g = 1 Ω		15	25		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristic		T 05 %C		1		1	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			6	A	
Pulse Diode Forward Current	I _{SM}				15		
Body Diode Voltage	V _{SD}	I _S = 4.1 A, V _{GS} = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	1		15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 4.1 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		8	20	nC	
Reverse Recovery Fall Time	t _a			8		ns	
Reverse Recovery Rise Time t _b				7		115	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

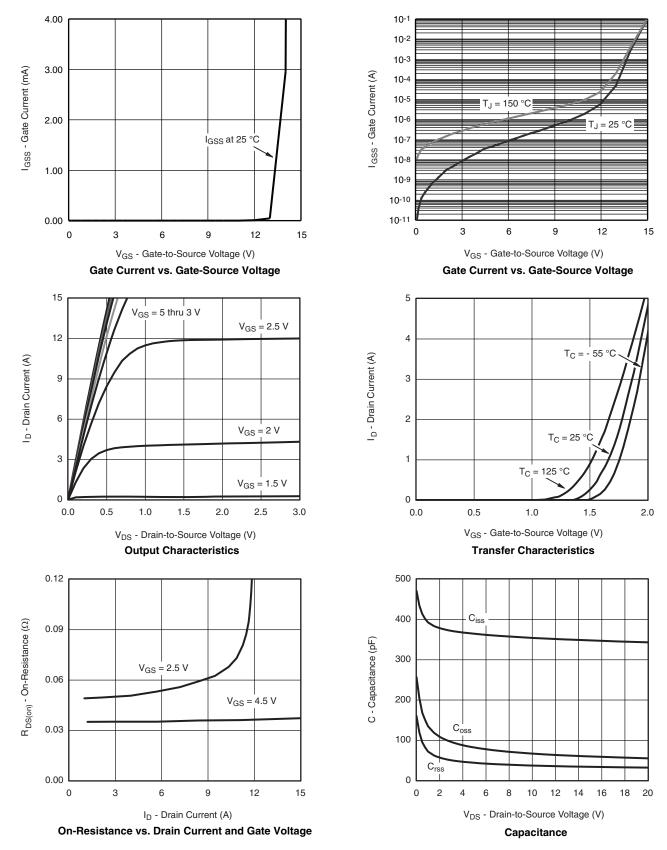
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

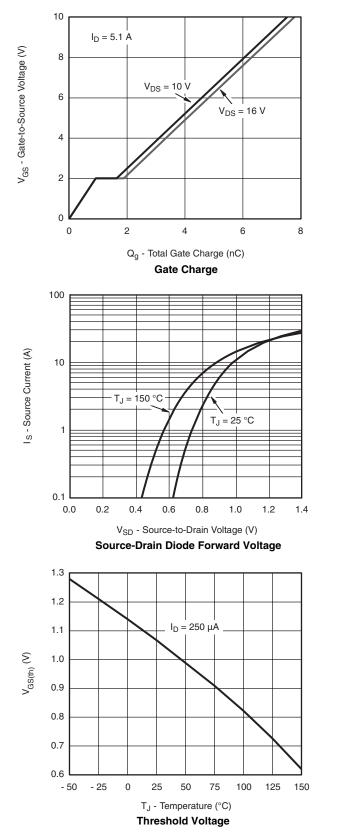


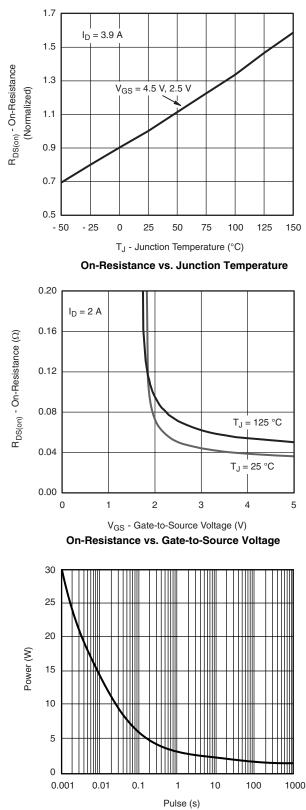
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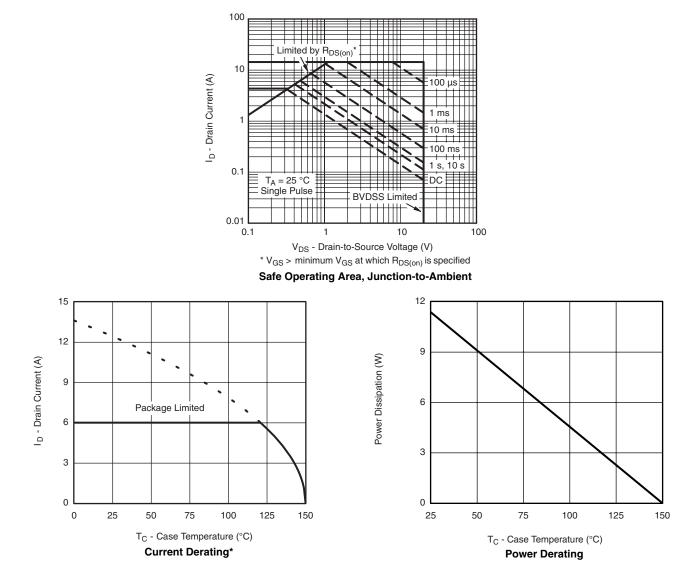
Single Pulse Power (Junction-to-Ambient)

New Product



SiA438EDJ Vishay Siliconix

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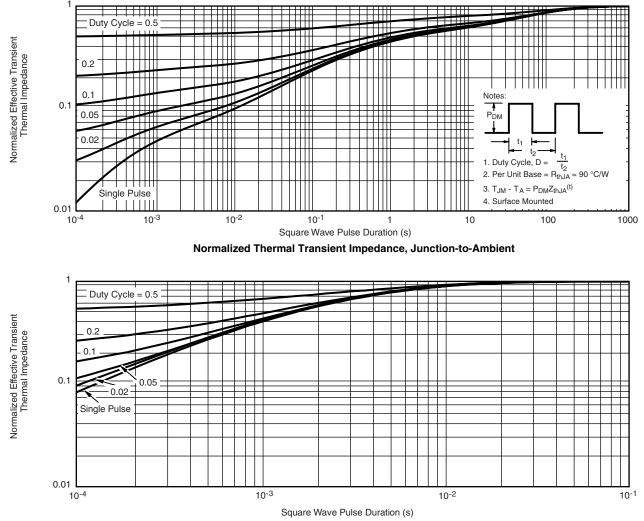


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?69092</u>.



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